



New Product

P-Channel 150-V (D-S) MOSFET

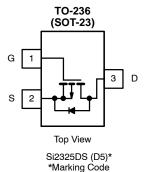
PRODUCT SUMMARY					
V _{DS} (V)	$r_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ)		
-150	1.2 @ V _{GS} = -10 V	-0.69	7.7		
	1.3 @ V _{GS} = -6.0 V	-0.66	<i>'.'</i>		

FEATURES

- TrenchFET® Power MOSFET
- Ultra Low On-Resistance
- Small Size

APPLICATIONS

 Active Clamp Circuits in DC/DC Power Supplies



Ordering Information: Si2325DS -T1—E3

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C UNLESS OTHERWISE NOTED)						
Parameter		Symbol	5 sec	Steady State	Unit	
Drain-Source Voltage		V _{DS}	-150		V	
Gate-Source Voltage		V_{GS}	±20			
Continuous Drain Current (T _J = 150°C) ^{a, b}	T _A = 25°C	ID	-0.69	-0.53	A	
	T _A = 70°C		-0.55	-0.43		
Pulsed Drain Current		I _{DM}	-1.6		^	
Continuous Source Current (Diode Conduction) ^{a, b}		Is	-1.0	-0.6		
Single-Pluse Avalanche Current		I _{AS}	4.5			
Single-Pulse Avalanche Energy	L = 1.0 mH	E _{AS}	1.01		mJ	
Marian Dania Diairatian h	T _A = 25°C	D	1.25	0.75	w	
Maximum Power Dissipation ^{a, b}	T _A = 70°C	P _D	0.8	0.48	VV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	–55 to 150		°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
	t ≤ 5 sec	_	75	100			
Maximum Junction-to-Ambient ^a	Steady State	R_{thJA}	120	166	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	40	50			

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

b. Pulse width limited by maximum junction temperature.

Vishay Siliconix

New Product



Parameter	Symbol	Test Conditions	Limits				
			Min	Тур	Max	Unit	
Static				•			
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = -250 μA	-150			.,	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-2.5		-4.5	·	
Gate-Body Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V			±100	nA	
7 O-t- V-lh Dusi- O	I _{DSS}	$V_{DS} = -150 \text{ V}, V_{GS} = 0 \text{ V}$			-1		
Zero Gate Voltage Drain Current		$V_{DS} = -150 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^{\circ}\text{C}$			-10	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -15 \text{ V}, V_{GS} = 10 \text{ V}$	-1.6			Α	
	_	$V_{GS} = -10 \text{ V}, I_D = -0.5 \text{ A}$		1.0	1.2	Ω	
Drain-Source On-Resistance ^a	r _{DS(on)}	$V_{GS} = -6.0$ V, $I_D = -0.5$ A		1.05	1.3		
Forward Transconductance ^a	9fs	$V_{DS} = -15 \text{ V}, I_D = -0.5 \text{ A}$		2.2		S	
Diode Forward Voltage	V_{SD}	$I_S = -1.0 \text{ A}, V_{GS} = 0 \text{ V}$		0.7	-1.2	V	
Dynamic ^b							
Total Gate Charge	Qg			7.7	12	nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = -75 \text{ V}, V_{GS} = 10 \text{ V}$ $I_{D} \cong -0.5 \text{ A}$		1.5			
Gate-Drain Charge	Q_{gd}	- D		2.5			
Gate Resistance	R_g	f = 1.0 MHz		9		Ω	
Input Capacitance	C _{iss}			340	510	pF	
Output Capacitance	C _{oss}	$V_{DS} = -25 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$		30			
Reverse Transfer Capacitance	C _{rss}			16			
Switching ^c				-		-	
Turn-On Time	t _{d(on)}	V_{DD} = -75 V, R _L = 75 Ω I _D \cong -1.0 A, V _{GEN} = -10 V		7	11	ne	
Tuni-On Time	t _r			11	17		
T 0# Time	t _{d(off)}	$R_g = 6 \Omega$		16	25	ns	
Turn-Off Time	t _f	·		11	17		
Body Diode Reverse Recovery Charge	Q_{rr}	I _F = 0.5 A, di/dt = 100 A/μs		90	135	nC	

- Notes

 a. Pulse test: PW ≤ 300 µs duty cycle ≤ 2%.

 b. For DESIGN AID ONLY, not subject to production testing.

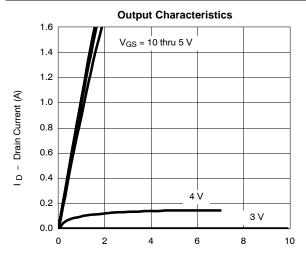
 c. Switching time is essentially independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

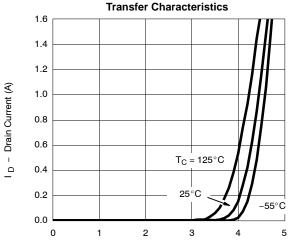


New Product

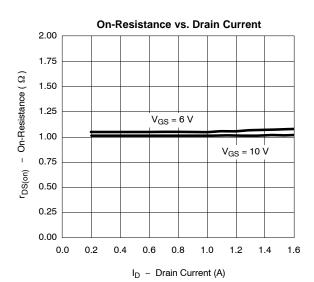
TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



V_{DS} - Drain-to-Source Voltage (V)

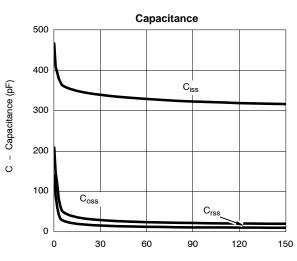


V_{GS} - Gate-to-Source Voltage (V)

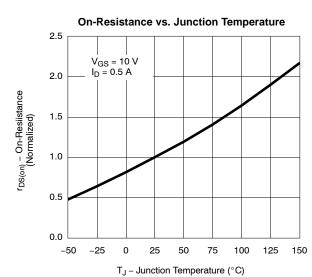


Gate Charge 10 V_{DS} = 75 V - Gate-to-Source Voltage (V) $I_D = 0.5 A$ 6 V_{GS} 2 0 0 2 4 5 6 7 8

Qg - Total Gate Charge (nC)



V_{DS} - Drain-to-Source Voltage (V)

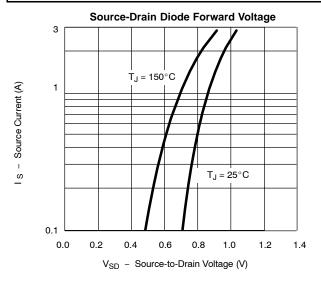


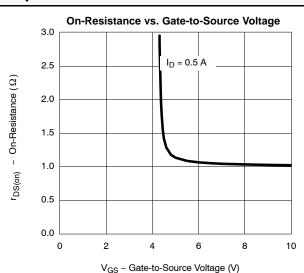
Document Number: 73238 S-42449—Rev. A, 10-Jan-05

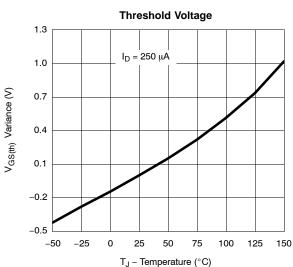
New Product

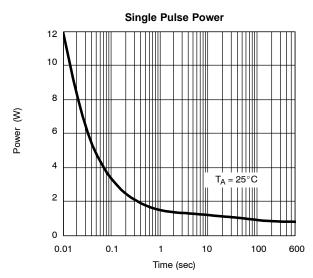


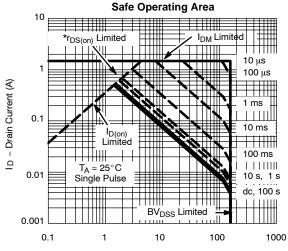
TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)





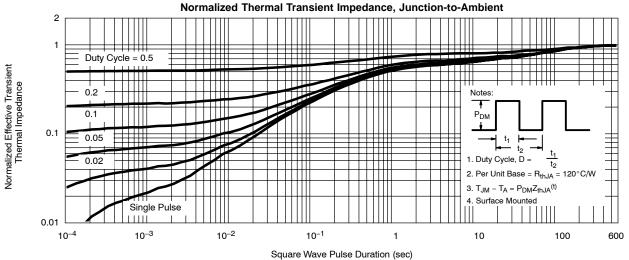






Vishay Siliconix

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?73238.



Vishay

Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.

Revision: 18-Jul-08

Document Number: 91000 www.vishay.com